ISD ChipCorder® ISD3900 Series DataSheet

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1 GENERAL DESCRIPTION

The ISD3900 is a multi-message ChipCorder[®] featuring digital compression, comprehensive memory management, and integrated analog/digital audio signal paths. The message management feature is designed to make message recording simple and address-free as well as make code development easier for playback-only applications. The ISD3900 utilizes Winbond 25X/25Q series flash memory to provide non-volatile audio record/playback for a two-chip solution. Unlike other ChipCorder series, the ISD3900 provides an I²S digital audio interface, faster digital recording, higher sampling frequency, and a signal path with SNR equivalent to 12bit resolution.

The ISD3900 can take digital audio data via I²S or SPI interface. When I²S input is selected, it will replace the analog audio inputs and will support sample rates of 32, 44.1 or 48 kHz depending upon clock configuration. When SPI interface is chosen, the sample rate of the audio data sent must be one of the ISD3900 supported sample rates.

The ISD3900 has built-in analog audio inputs, analog audio line driver, and speaker driver output. The two analog audio inputs to the device are: (1) AUXIN has a fixed gain configured by SPI command, and (2) ANAIN/ANAOUT has a fixed gain amplifier with the gain set by two external resistors. ANAIN/ANAOUT can also be used as a microphone differential input (ANAIN/ANAOUT becomes MIC+/MIC-) in conjunction with an automatic gain control (AGC) circuit configured by SPI command. Analog outputs are available in three forms: (1) AUXOUT is a single-ended voltage output; (2) AUDOUT can be configured as either a single-ended voltage output or a single-ended current output; (3) BTL (bridge-tied-load) is a differential voltage output.

2 FEATURES

- External Memory: support Winbond 25X/25Q SpiFlash
 - The addressing ability of ISD3900 is up to 128Mbit, which is 64-minute recording time based on 8kHz/4bit ADPCM
- Fast Digital Programming

• Programming rate can go up to 1Mbits/second mainly limited by the flash memory write rate Message Management

- Message Management
 - Perform address-free recording: The ISD3900 allocates memory for new recording requests and upon completion, returns a start address to the host via SPI interface
 - o Store pre-recorded audio (Voice Prompts) using high quality digital compression
 - o Use a simple index based command for playback
 - Execute pre-programmed macro scripts (Voice Macros) designed to control the configuration of the device and play back Voice Prompts sequences and message recordings
- Sample Rate
 - Seven record and playback sampling frequencies are available for a given master sample rate
 For example, the record and playback sampling frequencies of 4, 5.3, 6.4, 8, 12.8, 16 and
 32kHz are available when the device is clocked at a 32kHz master sample rate
 - For I²S operation, 32, 44.1 and 48kHz master sample rates are available with record and playback sampling frequencies scaling accordingly
 - Compression Algorithm
 - For recording
 - ADPCM: 2, 3, 4 or 5 bits per sample
 - µ-Law: 6, 7 or 8 bits per sample
 - Differential µ-Law: 6, 7 or 8 bits per sample
 - PCM: 8, 10 or 12 bits per sample. Each sampled value is stored as a code, offering no compression but preserving maximum resolution
 - o For Pre-Recorded Voice Prompt
 - µ-Law: 6, 7 or 8 bits per sample
 - Differential µ-Law: 6, 7 or 8 bits per sample
 - PCM: 8, 10 or 12 bits per sample
 - Enhanced ADPCM: 2, 3, 4 or 5 bits per sample
 - Variable-bit-rate optimized compression allows best possible compression given a metric

- of SNR and background noise levels
- Oscillator

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- o Internal oscillator with internal reference: 2.048 MHz with ±10% deviation
- o Internal oscillator with external resistor: 2.048 MHz with ±5% deviation when Rosc is 80k-ohm
- External crystal or clock input
- o I²S bit clock input
- Crystals and resonators support standard audio sampling rates of 2.048, 4.096, 8.192, 12.288 and11.2896MHz
- Input
 - o AUXIN: Analog input with 2-bit gain control configured by SPI command
 - ANAIN/ANAOUT:
 - Analog input with the gain set by two external resistors from ANAOUT to ANAIN, or
 - Microphone differential input (ANAIN/ANAOUT becomes MIC+/MIC-)
 - Digital AGC:
 - Automatic gain control of digitized data from the analog input
- Output
 - o PWM: Class D speaker driver to direct drive an 8Ω speaker or buzzer
 - PWM: Class D speaker driver which can deliver typical output power:
 - 8Ω load: 350mW @3.3V, 420mW @3.6V 8Ω load
 - 4Ω load: 520mW @3.3V, 620mW @3.6V 8Ω load
 - AUDOUT: configurable as a current or voltage single-ended line driver
 - AUXOUT: a single-ended voltage output
 - BTL: differential voltage output which can deliver typical output power:
 - 63mW for 8Ω load, 115mW for 4Ω load
- I/O
 - o SPI interface: MISO, MOSI, SCLK, SSB for commands and digital audio data
 - I²S interface: I²S_CLK, I²S_WS, I²S_SDI, I²S_SDO for digital audio data
 - \circ 8 GPIO pins (4 of the 8 GPIO pins share with I²S)
- Three 8-bit Volume Control set by SPI command for flexible mixing
 - VOLA: volume control for the digital audio data from I²S or analog inputs
 - o VOLB: volume control for the digital audio data from decompression block or SPI
 - VOLC: master volume control for PWM, AUDOUT, AUXOUT and I²S outputs
- Operating Voltage: 2.7-3.6V
- Standby Current: 1uA typical
- Package:
 - o LQFP-48
 - o Package is Halogen-free, RoHS-compliant and TSCA-compliant
- Temperature Options:
 - -40°C ~ 85°C

3 BLOCK DIAGRAM

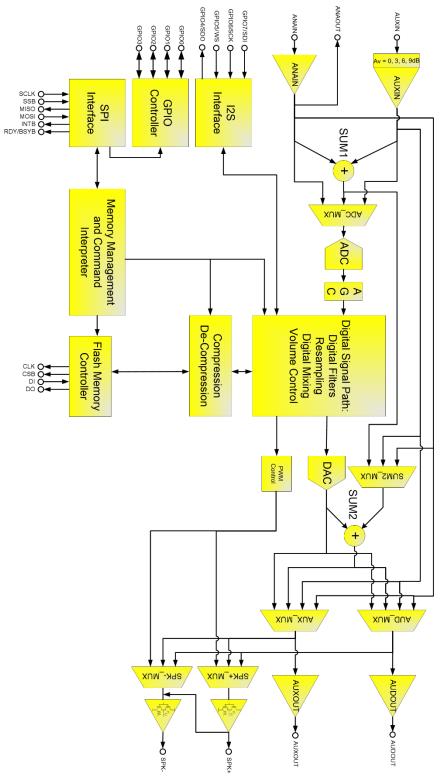


Figure 3-1 ISD3900 Block Diagram, ANAIN Selected

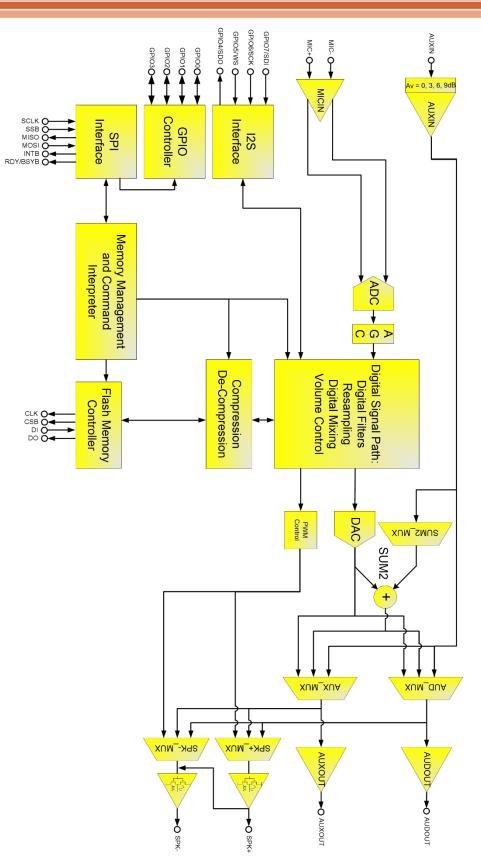


Figure 3-2 ISD3900 Block Diagram, MICIN Selected

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4 PINOUT CONFIGURATION

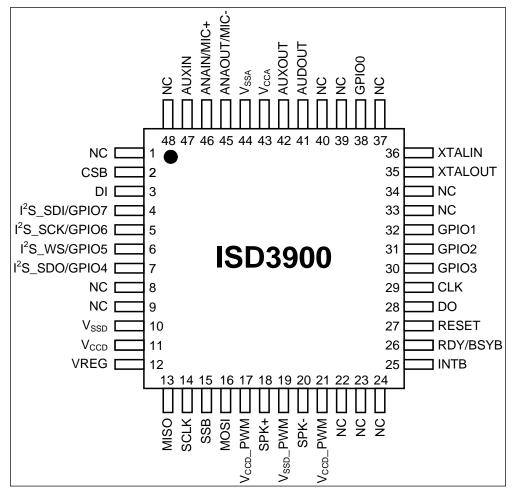


Figure 4-1 ISD3900 48-Lead LQFP Pin Configuration.

5 PIN DESCRIPTION

Pin #	Pin Name	I/O	Function
1	NC		This pin should be left unconnected.
2	CSB	0	Chip Select Bar of the external serial flash interface.
3	DI	Ι	Serial data input to external serial flash interface. Connects to data output (DO) of external flash memory.
4	I ² S_SDI/ GPIO7	I	Serial Data Input of the I ² S interface (If I2S is not used, this pin should be grounded). Or, can be configured as a GPIO pin.
5	I ² S_SCK/ GPIO6	I/O	Clock input in slave mode or clock output in master mode. This pin can be configured as an external clock buffer if I ² S is not used (If I2S is not used, this pin should be grounded). Or, can be configured as a GPIO pin.
6	I ² S_WS/ GPIO5	I/O	Word Select (WS) input in slave mode or WS output in master mode (If I2S is not used, this pin should be grounded). Or, can be configured as a GPIO pin.
7	I ² S_SDO/ GPIO4	0	Serial Data Output of the I ² S Interface (If I2S is not used, this pin should be left unconnected). Or, can be configured as a GPIO pin.
8	NC		This pin should be left unconnected.
9	NC		This pin should be left unconnected.
10	V _{SSD}	I	Digital Ground.
11	Vccd	I	Digital power supply.
12	VREG	0	A 1.8V regulator to supply the internal logic. A 0.1uF capacitor should be connected to this pin for supply decoupling and stability.
13	MISO	0	Master-In-Slave-Out. Serial output from the ISD3900 to the host. This pin is in tri-state when SSB=1.
14	SCLK	Ι	Serial Clock input to the ISD3900 from the host.
15	SSB	Ι	Slave Select input to the ISD3900 from the host. When SSB is low device is selected and responds to commands on the SPI interface.
16	MOSI	Ι	Master-Out-Slave-In. Serial input to the ISD3900 from the host.
17	Vccd_PWM	I	Digital Power for the PWM Driver.
18	SPK+	0	 PWM driver positive output. This SPK+ output, together with SPK- pin, provide a differential output to drive 8Ω speaker. During power down this pin is in tri-state. Or, can be configured as BTL which, together with SPK- pin, provide a differential voltage output. Or, can independently switch to AUDOUT or AUXOUT.
19	Vssd_PWM	I	Digital Ground for the PWM Driver.
20	SPK-	0	PWM driver negative output. This SPK- output, together with SPK+ pin, provides a differential output to drive 8Ω speaker. During power down this pin is tri-state.

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Pin #	Pin Name	I/O	Function
			Or, can be configured as BTL which, together with SPK+ pin, provide a differential voltage output. Or, can independently switch to AUDOUT or AUXOUT.
21	Vccd_PWM		Digital Power for the PWM Driver.
22	NC		This pin should be left unconnected.
23	NC		This pin should be left unconnected.
24	NC		This pin should be left unconnected.
25	INTB	0	Active low interrupt request pin. This pin is an open-drain output.
26	RDY/BSYB	0	An output pin to report the status of data transfer on the SPI interface. "High" indicates that ISD3900 is ready to accept new SPI commands or data.
27	RESET	Ι	Applying power to this pin will reset the chip. (A high pulse of 50ms or more will reset the chip.)
28	DO	0	Serial data output of the external serial flash interface. Connects to data input (DI) of external serial flash.
29	CLK	0	Serial data CLK of the external serial flash interface.
30	GPIO3	I/O	GPIO
31	GPIO2	I/O	GPIO
32	GPIO1	I/O	GPIO
33	NC		This pin should be left unconnected.
34	NC		This pin should be left unconnected.
35	XTALOUT	0	Crystal interface output pin.
36	XTALIN	I	The CLK_CFG register determines one of the following three configurations: (1) A crystal or resonator connected between the XTALOUT and XTALIN pins. (2) A resistor connected to GND as a reference current to the internal oscillator and left the XTALOUT unconnected. (3) An external clock input to the device and left the XTALOUT unconnected.
37	NC		This pin should be left unconnected.
38	GPIO0	I/O	GPIO
39	NC		This pin should be left unconnected.
40	NC		This pin should be left unconnected.
41	AUDOUT	0	Audio Out. This pin can be either a voltage output or a current output configured by the internal registers via SPI command. If AUDOUT is not used, this pin should be left unconnected.
42	AUXOUT	0	Aux Out. This pin is an analog voltage output. If AUXOUT is not used, this pin should be left unconnected.
43	Vcca	I	Analog power supply pin.
44	V _{SSA}	I	Analog ground pin.

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Pin #	Pin Name	I/O	Function
45	ANAOUT/ MIC-	0	Variable gain analog output with the gain set by feedback resistance to ANAIN. Or, can be configured as MIC- which, together with MIC+, provides a microphone differential input. If ANAIN/ANAOUT is not used, this pin should be left unconnected.
46	ANAIN/ MIC+	Ι	Variable gain analog input. Or, can be configured as MIC+ which, together with MIC-, provides a microphone differential input. If ANAIN/ANAOUT is not used, this pin should be left unconnected.
47	AUXIN	I	Auxiliary input with the gain set by SPI command If AUXIN is not used, this pin should be left unconnected.
48	NC		This pin should be left unconnected.

6 ELECTRICAL CHARACTERISTICS

6.1 ABSOLUTE MAXIMUM RATINGS

ABSOLUTE MAXIMUM RATINGS (PACKAGED PARTS)^[1]

CONDITIONS	VALUES
Junction temperature	130°C
Storage temperature range	-65°C to +150°C
Voltage Applied to any pins	(V _{SS} - 0.3V) to (V _{CC} + 0.3V)
Voltage applied to any pin (Input current limited to +/-20 mA)	$(V_{SS} - 1.0V)$ to $(V_{CC} + 1.0V)$
Power supply voltage to ground potential	-0.3V to +5.0V

^[1] Stresses above those listed may cause permanent damage to the device. Exposure to the absolute maximum ratings may affect device reliability. Functional operation is not implied at these conditions.

6.2 **OPERATING CONDITIONS**

OPERATING CONDITIONS (INDUSTRIAL PACKAGED PARTS)

CONDITIONS	VALUES
Operating temperature range (Case temperature)	-40°C to +85°C
Supply voltage (VDD) [1]	+2.7V to +3.6V
Ground voltage (Vss) [2]	0V
Input voltage (V _{DD}) ^[1]	0V to 3.6V
Voltage applied to any pins	(V _{SS} –0.3V) to (V _{DD} +0.3V)

NOTES:

 $^{[1]}V_{DD} = V_{CCA} = V_{CCD} = V_{CCPWM}$

 $^{[2]}V_{SS} = V_{SSA} = V_{SSD} = V_{SSPWM}$

6.3 DC PARAMETERS

PARAMETER	SYMBOL	MIN	TYP ^[1]	MAX	UNITS	CONDITIONS
Supply Voltage	Vdd	2.7		3.6	V	
Input Low Voltage	VIL	Vss-0.3		0.3xV _{DD}	V	
Input High Voltage	VIH	$0.7 x V_{DD}$		V _{DD}	V	
Output Low Voltage	Vol	Vss-0.3		0.3xV _{DD}	V	I _{OL} = 1mA
Output High Voltage	V _{OH}	$0.7 \mathrm{xV}_{\mathrm{DD}}$		V _{DD}	V	I _{OH} = -1mA
INTB Output Low Voltage	V _{OH1}			0.4	V	
Record Current	DD_Record			40	mA	V _{DD} = 3.6V, No load, Sampling freq = 16 kHz
Playback Current	IDD_Playback			30	mA	
Standby Current	I _{SB}		1	10	μA	V _{DD} = 3.6V
Input Leakage Current	lıL			±1	μA	Force V _{DD}

Notes: ^[1] Conditions V_{DD}=3V, T_A=25°C unless otherwise stated

6.4 AC PARAMETERS

6.4.1 Internal Oscillator

PARAMETER	SYMBOL	MIN	ТҮР	MAX	UNITS	CONDITIONS
Internal Oscillator with internal	FINT	-10%	2.048	+10	MHz	Vdd = 3V.
reference			MHz	%		At room temperature
Internal Oscillator with external resistor [1]	F _{Ext}	-5%	2.048 MHz	+5%	MHz	With 1% precision resistor, 80k-ohm. Vdd = 3V.
						At room temperature

Notes:

^[1] Characterization data shows that frequency deviation is +/- 5% across temperature and voltage ranges.

6.4.2 Inputs

ANAIN & MICIN

PARAMETER	SYMBOL	MIN	TYP ^[1]	MAX	UNITS	CONDITIONS
ANAIN Input Voltage	Vanain		10-1000		mV	Peak-to-Peak ^[2]
ANAIN Feed Back Resistance	RANA(FB)	40		100	KΩ	
MICIN Input Voltage	VMICIN		5-500		mV	Peak-to-Peak ^[2]

Notes: ^[1] Conditions V_{DD}=3V, T_{AB}=25°C unless otherwise stated ^[2] Depends on Gain Setting

AUXIN

PARAMETER	SYMBOL	MIN	TYP ^[1]	MAX	UNITS	CONDITIONS
AUXIN Input Voltage	VAUXIN		1000		mV	Peak-to-Peak ^[2]
Gain from AUXIN to AUXOUT/ANAOUT	Aauxin gain		0 to 9		dB	4 Gain Steps of 3db each
AUXIN Gain Accuracy	AAUXIN (GA)	-0.5		+0.5	dB	
AUXIN Input Resistance	Rauxin		20-40		KΩ	Depending on AUXIN Gain Setting

Notes: $^{[1]}$ Conditions V_{DD}=3V, T_A=25°C unless otherwise stated. $^{[2]}$ With 0db Gain setting.

6.4.3 Outputs

AUXOUT

PARAMETER	SYMBOL	MIN	TYP ^[1]	MAX	UNITS	CONDITIONS			
SINAD, AUXIN to AUXOUT	SINADAUXIN_AUXOUT		80		dB	Load 5K ^{[2][3]}			
SINAD, ANAIN to AUXOUT	SINADanain_auxout		80		dB	Load 5K ^{[2][3]}			
PSRR	PSRRAUXOUT		-40		dB	[4]			
DC Bias	VBIAS_AUXOUT			1.2	V				
Minimum Load Impedance	R _{L(AUXOUT)}	5			KΩ				
Maximum Load Capacitance	CL(AUXOUT)			0.1	nF				

Notes: $^{[1]}$ Conditions V_{DD}=3V, T_A=25°C unless otherwise stated.

^[2] 1 Vpp 1KHz signal applied at AUXIN/ANAIN with 0db Gain setting.

^[3] All measurements are C-message weighted.

 $^{[4]}$ Measured with 1KHz, 100 mVpp sine wave applied to V_{CCA} pins.

AUDOUT

PARAMETER	SYMBOL	MIN	TYP ^[1]	MAX	UNITS	CONDITIONS
SINAD, AUXIN to AUDOUT ^[5]	SINADAUXIN_AUDOUT		80		dB	Load 5K ^{[2][3]}
SINAD, ANAIN to AUDOUT ^[5]	SINADanain_audout		80		dB	Load 5K ^{[2][3]}
PSRR ^[5]	PSRRAUDOUT		-40		dB	[4]
DC Bias ^[5]	VBIAS_AUDOUT			1.2	V	
Minimum Load Impedance ^[5]	R _{L(AUDOUT)}	5			KΩ	

Maximum Load Capacitance ^[5]	C _{L(AUDOUT)}			0.1	nF	
Output Current ^[6]	Iaudout	0	3	6	mA	[2][6]

Notes: [1] Conditions V_{cc}=3V, T_A=25°C unless otherwise stated.

^[2] 1 Vpp 1KHz signal applied at AUXIN/ANAIN with 0db Gain setting.

^[3] All measurements are C-message weighted.

^[4] Measured with 1Khz, 100 mVpp sine wave applied to V_{CCA} pins.

^[5] Configured as AUDOUT(Voltage Output).

^[6] Configured as AUDOUT(Current Output).

SPEAKER OUTPUTS

PARAMETER	SYMBOL	MIN	TYP ^[1]	MAX	UNITS	CONDITIONS
SNR, AUXIN to SPK+/SPK-	SNR _{AUXIN_SPK}		60		dB	Load 1500 ^{[2][3]}
SNR, ANAIN to SPK+/SPK-	SNRANAIN_SPK		60		dB	Load 150Ω ^{[2][3]}
THD, AUXIN to SPK+/SPK-	THD %		<1%			Load 8Ω ^[2]
Minimum Load Impedance	RL(SPK)	4	8		Ω	

Notes: $^{[1]}$ Conditions V_{cc}=3V, T_A=25°C unless otherwise stated.

^[2] 1 Vpp 1KHz signal applied at AUXIN/ANAIN with 0db Gain setting.

^[3] All measurements are C-message weighted.

SPEAKER OUTPUT POWER

Conditions: V_{CCD} = 3.3V, 16KHz sample rate, 12bit PCM, T_A = +25°C, 1kHz signal

PARAMETER	SYMBOL	MODE	MIN	TYP ^[1]	MAX	UNITS	CONDITIONS
				350		mW	@ 3.3V, Load 8Ω, 0.4% THD
	Class-D		420		mW	@ 3.6V, Load 8Ω, 0.4% THD	
		^{SPK} Class-AB BTL		520		mW	@ 3.3V, Load 4Ω, 0.8% THD
Output Power	Pout_spk			620		mW	@ 3.3V, Load 4Ω, 0.8% THD
				63		mW	Load 8Ω, 0.1% THD ^[1]
				125		mW	Load 4Ω, 0.1% THD ^[1]

Notes: [1] CLASS AB BTL is fixed referenced from bandgap, independent from V_{CCA}.

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6.4.4 SPI Timing

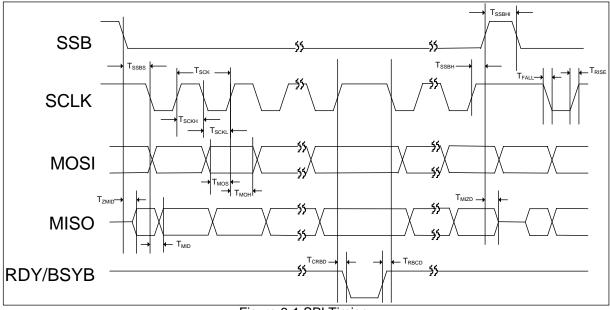


Figure 6-1 SPI Timing

SYMBOL	DESCRIPTION	MIN	ТҮР	MAX	UNIT
Т _{SCK}	SCLK Cycle Time	60			ns
Т _{SCKH}	SCLK High Pulse Width	25			ns
TSCKL	SCLK Low Pulse Width	25			ns
TRISE	Rise Time for All Digital Signals			10	ns
T _{FALL}	Fall Time for All Digital Signals			10	ns
T _{SSBS}	SSB Falling Edge to 1 st SCLK Falling Edge Setup Time	30			ns
T _{SSBH}	Last SCLK Rising Edge to SSB Rising Edge Hold Time	30ns		50us	
Tssbhi	SSB High Time between SSB Lows				ns
T _{MOS}	MOSI to SCLK Rising Edge Setup Time				ns
Тмон	SCLK Rising Edge to MOSI Hold Time	15			ns
Tzmid	Delay Time from SSB Falling Edge to MISO Active			12	ns
T _{MIZD}	Delay Time from SSB Rising Edge to MISO Tri-state			12	ns
T _{MID}	Delay Time from SCLK Falling Edge to MISO			12	ns
T _{CRBD}	Delay Time from SCLK Rising Edge to RDY/BSYB Falling Edge			12	ns
T _{RBCD}	Delay Time from RDY/BSYB Rising Edge to SCLK Falling Edge	0			ns

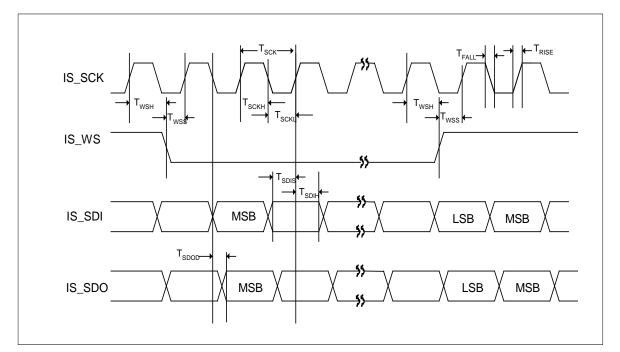


Figure 6-2 I²S Timing

SYMBOL	DESCRIPTION	MIN	ТҮР	MAX	UNIT
Тѕск	IS_SCK Cycle Time	60			ns
Тѕскн	IS_SCK High Pulse Width	25			ns
T _{SCKL}	IS_SCK Low Pulse Width	25			ns
TRISE	Rise Time for All Digital Signals			10	ns
TFALL	Fall Time for All Digital Signals			10	ns
T _{WSS}	WS to IS_SCK Rising Edge Setup Time	20			ns
Тwsн	IS_SCK Rising Edge to IS_WS Hold Time	20			ns
Tsdis	IS_SDI to IS_SCK Rising Edge Setup Time				ns
T _{SDIH}	IS_SCK Rising Edge to IS_SDI Hold Time	15			ns
Tsdod	Delay Time from IS_SCLK Falling Edge to IS_SDO			12	ns

7 APPLICATION DIAGRAM

The following applications example is for references only. It makes no representation or warranty that such applications shall be suitable for the use specified. Each design has to be optimized in its own system for the best performance on voice quality, current consumption, functionalities and etc.

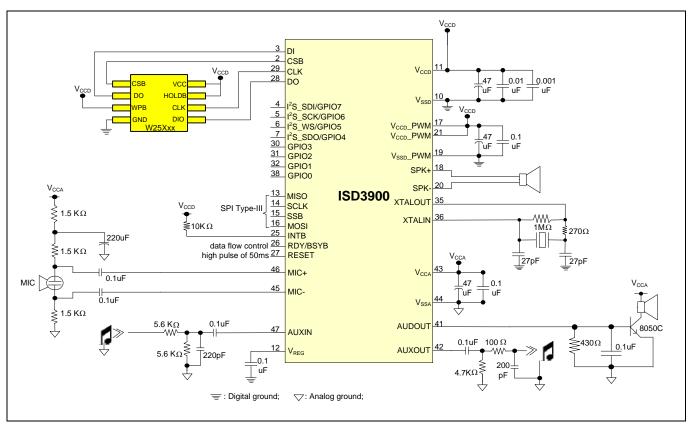
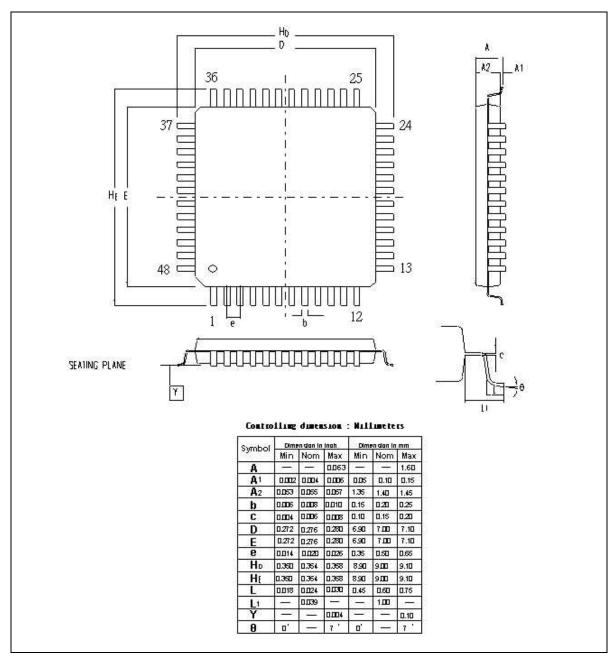


Figure 7-1 ISD3900 Application Diagram

8 PACKAGE SPECIFICATION

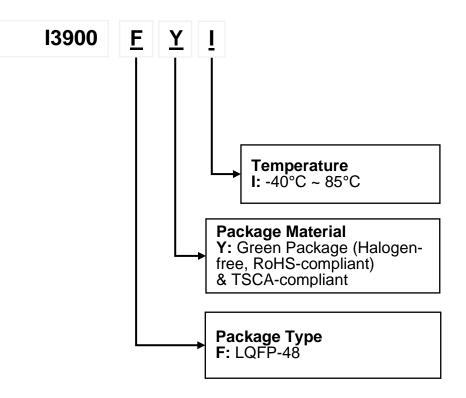
8.1 48 LEAD LQFP(7x7x1.4MM FOOTPRINT 2.0MM)





ISD3900

9 ORDERING INFORMATION



Package Number	Part Number	Ordering Number	Duration	Package	Temperature	Notes
ISD3900FYI	ISD3900FYI	1 39 00FYI	0 ~ 64min	LQFP-48	-40°C ~ 85°C	

10 REVISION HISTORY

REVISION	DATE	DESCRIPTION
1.0	July 1, 2010	Initial Release
1.1	Dec 13, 2010	Fix the typo of internal memory to external memory
1.2	May 6, 2011	Add Absolute Maximum Ratings
1.3	Aug 30, 2011	Update register 0x19 ~ 0x1F description Update output power description
1.4	Mar 29, 2020	Update Document Format
1.5	Jun 15, 2021	Update Ordering Information Update output power Remove buzzer description
1.6	Feb 1, 2023	Update Halogen-free, RoHS-compliant and TSCA-compliant description

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